

T-01-17

## SILICON RECTIFIER DIODES



Silicon rectifier diodes in DO-4 metal envelopes, intended for use in power rectifier applications. The series consists of the following types:

Normal polarity (cathode to stud): BYX38-300 to 1200.

Reverse polarity (anode to stud): BYX38-300R to 1200R.

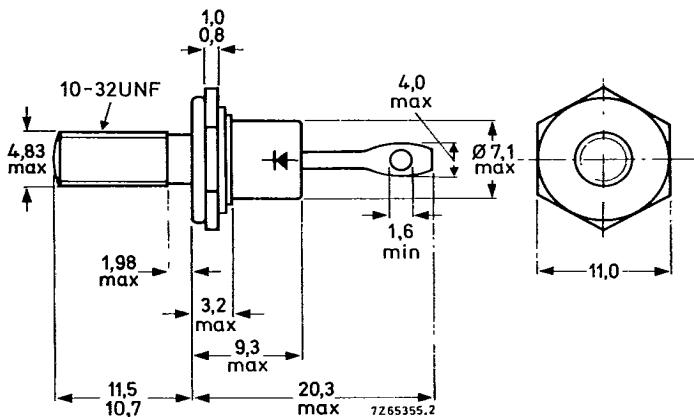
## QUICK REFERENCE DATA

		BYX38-300(R)	600(R)	1200(R)
Repetitive peak reverse voltage	V <sub>RRM</sub>	max. 300	600	1200 V
Average forward current	I <sub>F(AV)</sub>	max.	6	A
Non-repetitive peak forward current	I <sub>FSM</sub>	max.	50	A

## MECHANICAL DATA

Dimensions in mm

DO-4



Net mass: 6 g

Torque on nut: min. 0,9 Nm

(9 kg cm)

Diameter of clearance hole: max. 5,2 mm

max. 1,7 Nm

(17 kg cm)

Accessories supplied on request:  
see ACCESSORIES section

Supplied with device: 1 nut, 1 lock washer

Nut dimensions across the flats: 9,5 mm

The mark shown applies to normal polarity types.



Products approved to CECC 50 009-019 available on request.

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RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

		BYX38-300(R)	600(R)	1200(R)	
Non-repetitive peak reverse voltage ( $t \leq 10$ ms)	$V_{RSM}$	max. 300	600	1200	V
Repetitive peak reverse voltage ( $\delta \leq 0,01$ )	$V_{RRM}$	max. 300	600	1200	V
Crest working reverse voltage	$V_{RWM}$	max. 200	400	800	V
Continuous reverse voltage	$V_R$	max. 200	400	800	V

Currents

Average forward current (averaged over any 20 ms period) up to $T_{mb} = 110$ °C at $T_{mb} = 125$ °C	$I_{F(AV)}$	max.	6	A
	$I_{F(AV)}$	max.	4	A
R.M.S. forward current	$I_{F(RMS)}$	max.	10	A
Repetitive peak forward current	$I_{FRM}$	max.	50	A
Non-repetitive peak forward current ( $t = 10$ ms; half sine-wave) $T_j = 150$ °C prior to surge: with reapplied $V_{RWM}$ :max	$I_{FSM}$	max.	50	A
$I^2t$ for fusing ( $t = 10$ ms)	$I^2t$	max.	13	$A^2s$

Temperatures

Storage temperature	$T_{stg}$	-55 to +150	°C
Junction temperature	$T_j$	max.	150 °C

**THERMAL RESISTANCE**

From junction to ambient in free air	$R_{th j-a}$	=	50	°C/W
From junction to mounting base	$R_{th j-mb}$	=	4	°C/W
From mounting base to heatsink with heatsink compound	$R_{th mb-h}$	=	0,5	°C/W
without heatsink compound	$R_{th mb-h}$	=	0,6	°C/W
Transient thermal impedance; $t = 1$ ms	$Z_{th j-mb}$	=	0,3	°C/W

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**CHARACTERISTICS**

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Forward voltage

$I_F = 20 \text{ A}$ ;  $T_j = 25^\circ\text{C}$

$V_F < 1,7 \text{ V}$  1)

Reverse current

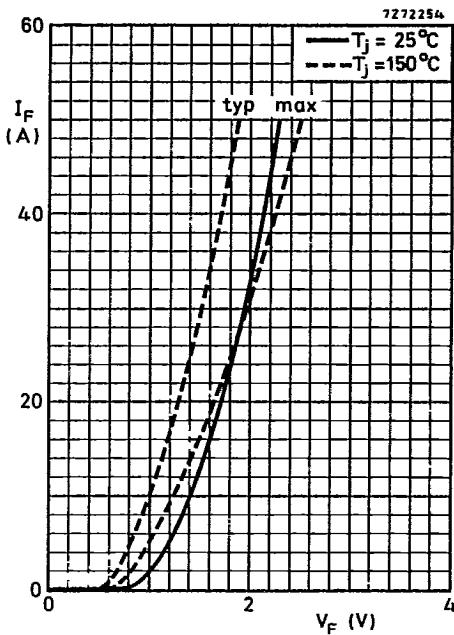
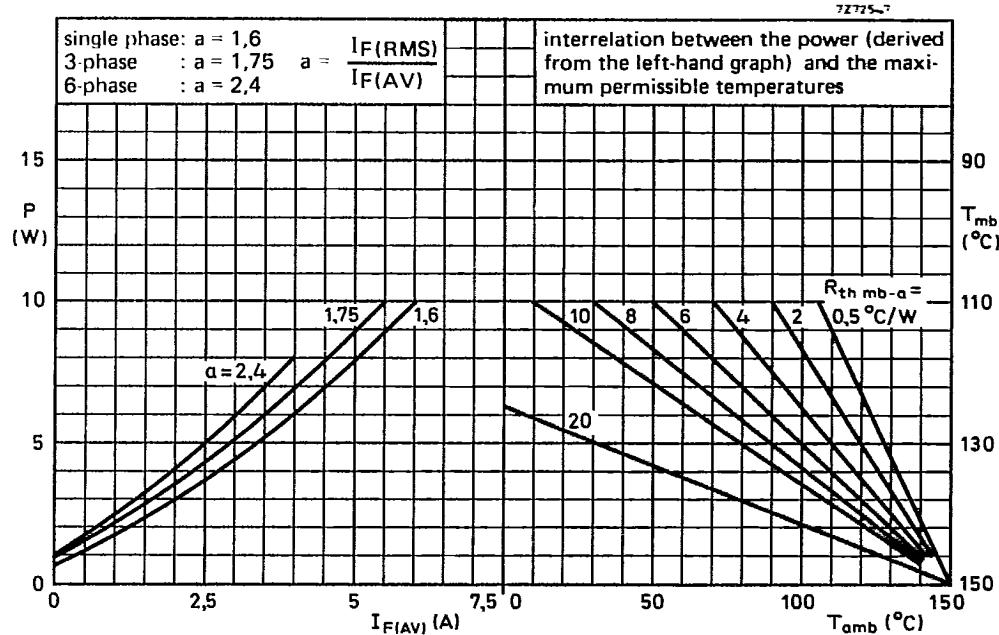
$V_R = V_{RWMM\max}$ ;  $T_j = 125^\circ\text{C}$

$I_R < 200 \mu\text{A}$

**OPERATING NOTES**

1. The top connector should neither be bent nor twisted; it should be soldered into the circuit so that there is no strain on it.  
During soldering the heat conduction to the junction should be kept to a minimum.
2. Where there is a possibility that transients, due to the energy stored in the transformer, will exceed the maximum permissible non-repetitive peak reverse voltage, see General Section for information on damping circuits.

1) Measured under pulse conductions to avoid excessive dissipation.

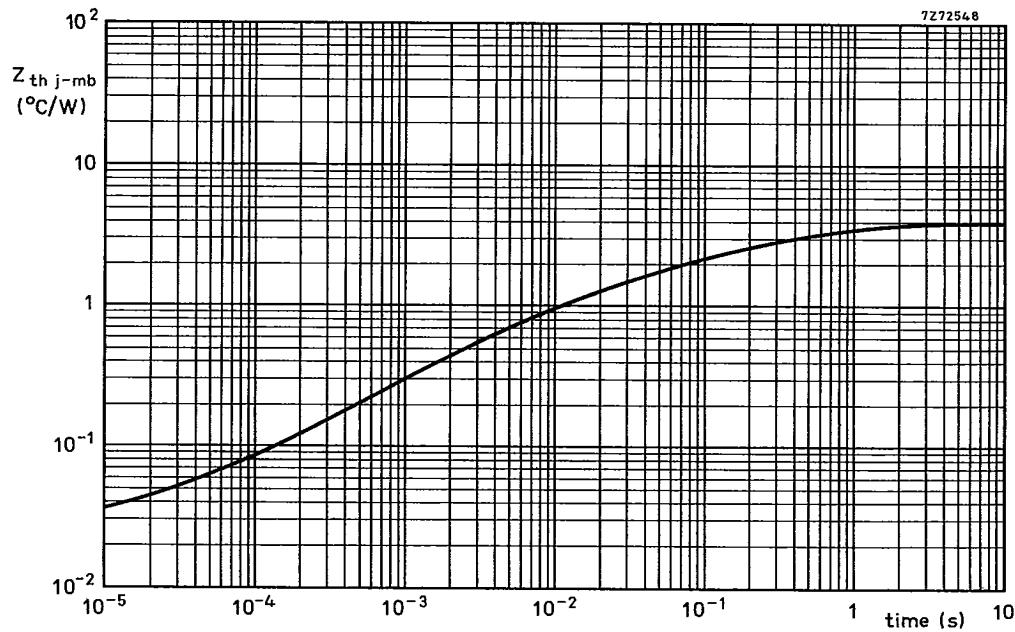
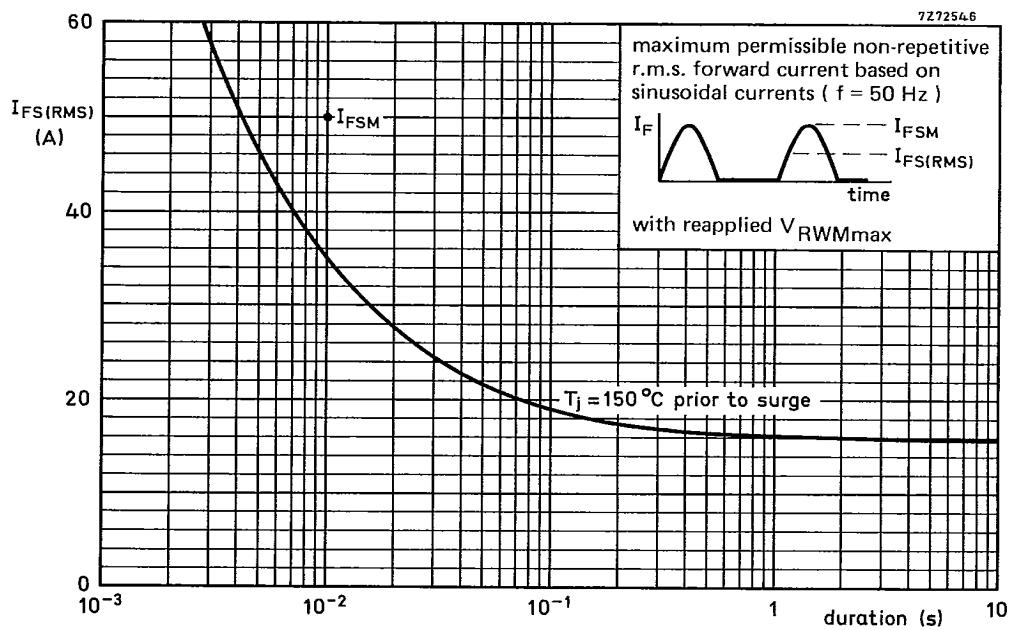


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BYX38  
SERIES

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